

Switching Transistor NPN Silicon MMBT4401WT1G

Features

- Moisture Sensitivity Level: 1
- ESD Rating: Human Body Model; 4 kV, Machine Model; 400 V
- NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

COLLECTOR 3 1 BASE 2 EMITTER



SC-70 (SOT-323) CASE 419 STYLE 3

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector - Emitter Voltage	V_{CEO}	40	Vdc
Collector - Base Voltage	V_{CBO}	60	Vdc
Emitter – Base Voltage	V_{EBO}	6.0	Vdc
Collector Current – Continuous	Ic	600	mAdc

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation FR-5 Board T _A = 25°C	P _D	150	mW
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	833	°C/W
Junction and Storage Temperature	T _J , T _{stg}	-55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

MARKING DIAGRAM



(Note: Microdot may be in either location)

*Date Code orientation may vary depending upon manufacturing location.

ORDERING INFORMATION

Device	Package	Shipping [†]
MMBT4401WT1G	SC-70 (Pb-Free)	3000 / Tape & Reel
NSVMMBT4401WT1G	SC-70 (Pb-Free)	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characte	Symbol	Min	Max	Unit	
OFF CHARACTERISTICS					
Collector - Emitter Breakdown Voltage (Note	V _{(BR)CEO}	40	_	Vdc	
Collector – Base Breakdown Voltage (I _C = 0.1	mAdc, I _E = 0)	V _{(BR)CBO}	60	-	Vdc
Emitter – Base Breakdown Voltage (I _E = 0.1 m	nAdc, I _C = 0)	V _{(BR)EBO}	6.0	-	Vdc
Base Cutoff Current (V _{CE} = 35 Vdc, V _{EB} = 0.4	4 Vdc)	I _{BEV}	_	0.1	μAdc
ON CHARACTERISTICS (Note 1)					
$\begin{array}{l} \text{DC Current Gain} \\ \text{($I_C=0.1$ mAdc, $V_{CE}=1.0$ Vdc)} \\ \text{($I_C=1.0$ mAdc, $V_{CE}=1.0$ Vdc)} \\ \text{($I_C=10$ mAdc, $V_{CE}=1.0$ Vdc)} \\ \text{($I_C=150$ mAdc, $V_{CE}=1.0$ Vdc)} \\ \text{($I_C=500$ mAdc, $V_{CE}=2.0$ Vdc)} \end{array}$		h _{FE}	20 40 80 100 40	- - - 300 -	-
Collector – Emitter Saturation Voltage ($I_C = 150 \text{ mAdc}$, $I_B = 15 \text{ mAdc}$) ($I_C = 500 \text{ mAdc}$, $I_B = 50 \text{ mAdc}$)	V _{CE(sat)}	- -	0.4 0.75	Vdc	
Base – Emitter Saturation Voltage ($I_C = 150 \text{ mAdc}$, $I_B = 15 \text{ mAdc}$) ($I_C = 500 \text{ mAdc}$, $I_B = 50 \text{ mAdc}$)	V _{BE(sat)}	0.75 -	0.95 1.2	Vdc	
Collector Cutoff Current (V _{CE} = 35 Vdc, V _{EB} =	= 0.4 Vdc)	I _{CEX}	-	0.1	μAdc
SMALL-SIGNAL CHARACTERISTICS					
Current - Gain - Bandwidth Product (I _C = 20 I	f _T	250	_	MHz	
Collector-Base Capacitance ($V_{CB} = 5.0 \text{ Vdc}$, I _E = 0, f = 1.0 MHz)	C _{cb}	-	6.5	pF
Emitter-Base Capacitance ($V_{EB} = 0.5 \text{ Vdc}, I_{C}$; = 0, f = 1.0 MHz)	C _{eb}	-	30	pF
Input Impedance ($I_C = 1.0 \text{ mAdc}$, $V_{CE} = 10 \text{ Ve}$	h _{ie}	1.0	15	kΩ	
Voltage Feedback Ratio ($I_C = 1.0 \text{ mAdc}, V_{CE}$	h _{re}	0.1	8.0	X 10 ⁻⁴	
Small – Signal Current Gain (I _C = 1.0 mAdc, V	h _{fe}	40	500	-	
Output Admittance ($I_C = 1.0 \text{ mAdc}$, $V_{CE} = 10$	h _{oe}	1.0	30	μmhos	
SWITCHING CHARACTERISTICS					
Delay Time	(V _{CC} = 30 Vdc, V _{EB} = 2.0 Vdc,	t _d	_	15	
Rise Time	$I_C = 150 \text{ mAdc}, I_{B1} = 15 \text{ mAdc})$	t _r	-	20	ns
Storage Time	(V _{CC} = 30 Vdc, I _C = 150 mAdc,	t _s	-	225	
Fall Time	$I_{B1} = I_{B2} = 15 \text{ mAdc}$	t _f	_	30	ns

^{1.} Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2.0%.

SWITCHING TIME EQUIVALENT TEST CIRCUITS

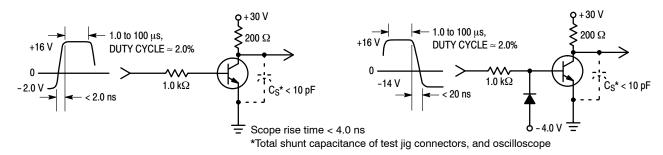


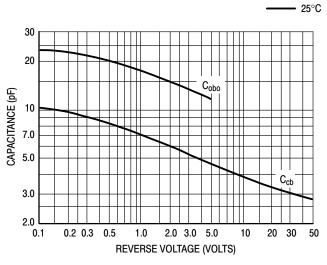
Figure 1. Turn-On Time

Figure 2. Turn-Off Time

TRANSIENT CHARACTERISTICS

— 100°C

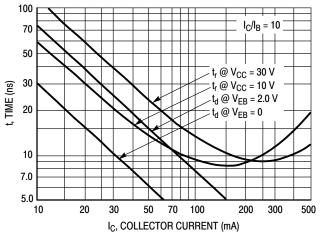
10



7.0 $V_{CC} = 30 \text{ V}$ 5.0 $I_{\rm C}/I_{\rm B} = 10$ 3.0 2.0 Q, CHARGE (nC) 1.0 0.7 0.5 0.3 0.2 Q_A 0.1 20 70 200 10 300 500 IC, COLLECTOR CURRENT (mA)

Figure 3. Capacitances

Figure 4. Charge Data



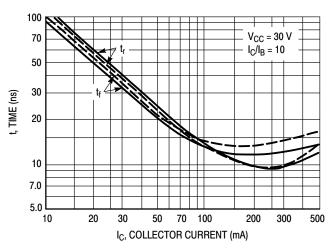
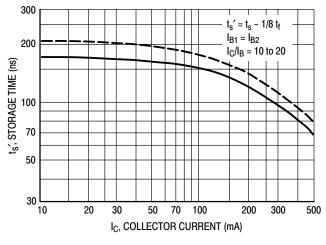


Figure 5. Turn-On Time

Figure 6. Rise and Fall Times



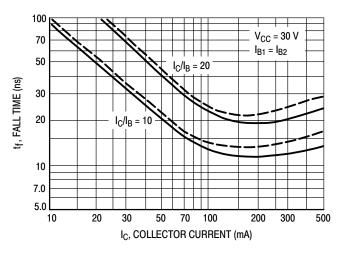


Figure 7. Storage Time

Figure 8. Fall Time

SMALL-SIGNAL CHARACTERISTICS NOISE FIGURE

V_{CE} = 10 Vdc, T_A = 25°C; Bandwidth = 1.0 Hz

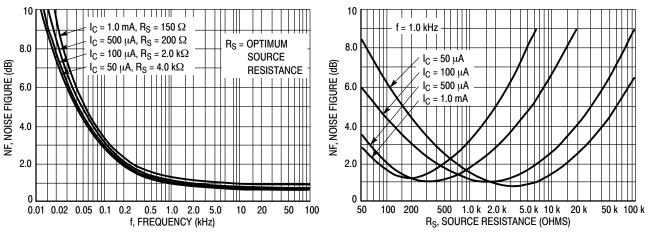


Figure 9. Frequency Effects

Figure 10. Source Resistance Effects

h PARAMETERS

 $V_{CE} = 10 \text{ Vdc}, f = 1.0 \text{ kHz}, T_A = 25^{\circ}\text{C}$

This group of graphs illustrates the relationship between h_{fe} and other "h" parameters for this series of transistors. To obtain these curves, a high-gain and a low-gain unit were selected from the MMBT4401WT1 lines, and the same units were used to develop the correspondingly numbered curves on each graph.

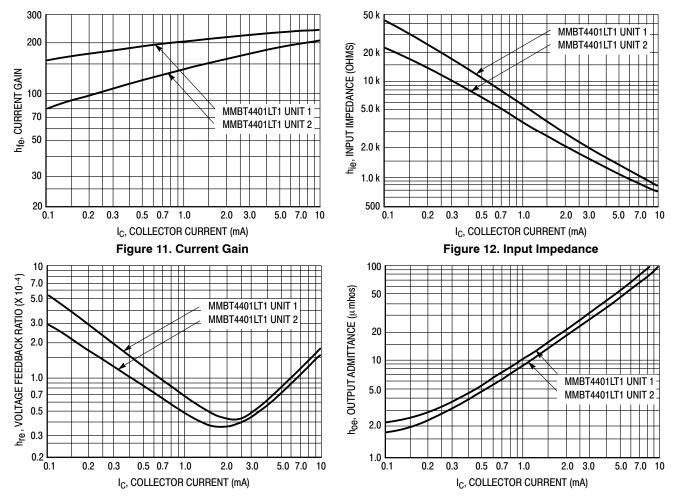
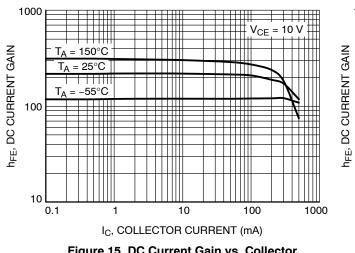


Figure 13. Voltage Feedback Ratio

Figure 14. Output Admittance

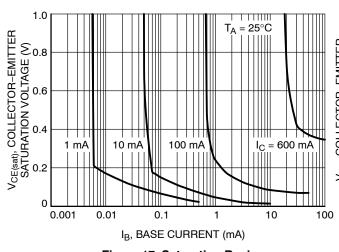
STATIC CHARACTERISTICS



1000 $T_A = 150^{\circ}C$ $T_A = 25^{\circ}C$ $T_A = -55^{\circ}C$ 100 $T_A = -55^{\circ}C$ $T_A = -55^{\circ}C$

Figure 15. DC Current Gain vs. Collector Current

Figure 16. DC Current Gain vs. Collector Current



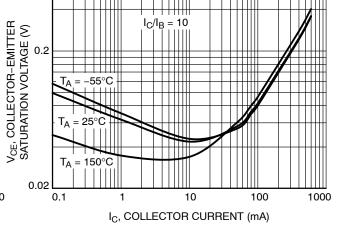
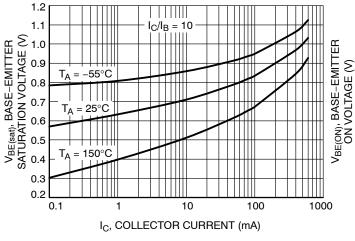


Figure 17. Saturation Region

Figure 18. Collector Emitter Saturation Voltage vs. Collector Current



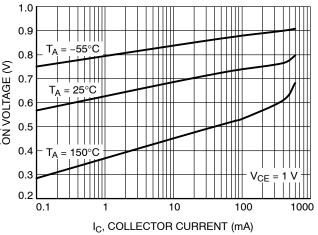
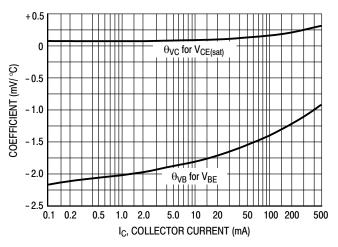


Figure 19. Base Emitter Saturation Voltage vs.
Collector Current

Figure 20. Base Emitter Turn-ON Voltage vs.
Collector Current





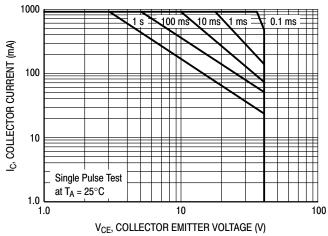


Figure 22. Safe Operating Area







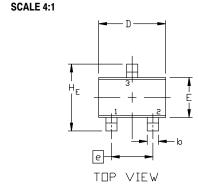
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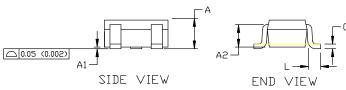
DATE 11 OCT 2022

NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: INCH

	MILLIMETERS				INCHES	
DIM	MIN.	N□M.	MAX.	MIN.	N□M.	MAX.
Α	0.80	0.90	1.00	0.032	0.035	0.040
A1	0.00	0.05	0.10	0.000	0.002	0.004
A2		0.70 REF	-		0.028 BS	C
b	0.30	0.35	0.40	0.012	0.014	0.016
С	0.10	0.18	0.25	0.004	0.007	0.010
D	1.80	2.00	2.20	0.071	0.080	0.087
E	1.15	1.24	1.35	0.045	0.049	0.053
е	1.20	1.30	1.40	0.047	0.051	0.055
e1	0.65 BSC			0.026 BS	C	
L	0.20	0.38	0.56	0.008	0.015	0.022
HE	2.00	2.10	2.40	0.079	0.083	0.095





GENERIC MARKING DIAGRAM

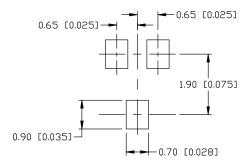


XX = Specific Device Code

M = Date Code

■ = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.



For additional information on our Pb-Free strategy and soldering details, please download the IIN Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.

SOLDERING FOOTPRINT

STYLE 1: CANCELLED	STYLE 2: PIN 1. ANODE 2. N.C. 3. CATHODE	STYLE 3: PIN 1. BASE 2. EMITTER 3. COLLECTOR	STYLE 4: PIN 1. CATHODE 2. CATHODE 3. ANODE	STYLE 5: PIN 1. ANODE 2. ANODE 3. CATHODE	
STYLE 6:	STYLE 7:	STYLE 8:	STYLE 9:	STYLE 10:	STYLE 11:
PIN 1. EMITTER	PIN 1. BASE	PIN 1. GATE	PIN 1. ANODE	PIN 1. CATHODE	PIN 1. CATHODE
2. BASE	2. EMITTER	2. SOURCE	2. CATHODE	2. ANODE	CATHODE
COLLECTOR	COLLECTOR	3. DRAIN	CATHODE-ANODE	3. ANODE-CATHODE	CATHODE

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